

概述 Description

HL826X 是一款由发光二极管和光电晶体管组成的双通道光电耦合器。八引脚封装，两种形式（DIP、SMD）。
The HL826X is a dual channel photocoupler composed of light emitting diodes and phototransistors. It is packaged in a 8-pin package of two forms such as DIP、SMD.

特性 Features

- 电流转换比(CTR)范围: 200%~600% ($I_F=5\text{mA}$, $V_{CE}=5\text{V}$, $T_a=25^\circ\text{C}$)
Current transfer ratio: 200%~600% ($I_F=5\text{mA}$, $V_{CE}=5\text{V}$, $T_a=25^\circ\text{C}$)
- 输入-输出隔离电压 ($V_{ISO}=5000\text{ Vrms}$)
High isolation voltage between input and output($V_{ISO}=5000\text{ Vrms}$)
- 集电极-发射极击穿电压 $BV_{CEO}\geq 80\text{V}$
Collector - emitter breakdown voltage $BV_{CEO}\geq 80\text{V}$
- 工作温度: $-55^\circ\text{C}\sim 110^\circ\text{C}$
Operating Temperature: $-55^\circ\text{C}\sim 110^\circ\text{C}$
- 符合加强绝缘标准
Meet reinforced insulation standards
- 符合安规标准: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022
Safety standards approval: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022

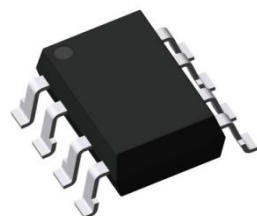
应用 Applications

- 开关电源, 智能电表
Switching power supply, intelligent meter
- 工业控制, 测量仪器
Industrial control, measuring instruments
- 办公设备, 比如复印机
Office equipment such as copiers
- 家用电器, 比如空调、风扇、热水器等
Household appliances: such as air conditioners, fans, water heaters, etc.

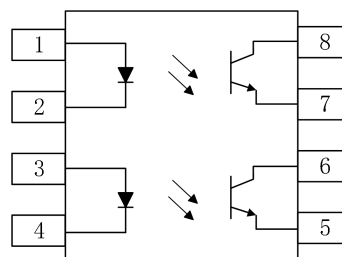
封装和原理图 Package and Schematic Diagram



DIP8



SMD8



Pin Configuration

- 1. Anode
- 2. Cathode
- 7. Emitter
- 8. Collector

产品型号命名规则 Order Code

HL 826 X - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦ ⑧

① 公司代码 Company Code (HL: 鸿利鲲鹏 Hongli Kunpeng)

② 产品系列 Product Series (826: 826)

③ CTR 档位 Classification (代码 Code: C or D)

④ 框架类型 Lead Frame (Cu: 铜框架 Copper, Fe: 铁框架 Ferrum)

⑤ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)

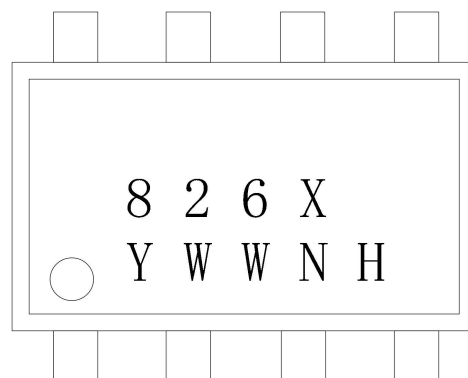
⑥ 封装形式 Package (D:DIP, S:SMD)

⑦ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or left blank)

⑧ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中的“X”代表产品分档: C、D
“X”denotes the classification: C、D
- 印字中“Y”代表年份; A(2018),B(2019),C(2020).....
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号
“WW”denotes Week's number
- 印字中“N”代表星期几
“N”denotes the day of the week
- 印字中的“H”代表无卤
“H”denotes Halogen-free



绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	> 7.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	> 7.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	> 0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	V_{IORM}	1500	V_{peak}	DIN/EN/IEC EN60747-5-5
瞬态隔离电压 Transient isolation voltage	V_{IOTM}	7000	V_{peak}	DIN/EN/IEC EN60747-5-5
隔离电压 Isolation Voltage	V_{iso}	> 5000	V_{rms}	For 1 min, RH < 60%

极限参数 Absolute Maximum Ratings (Ta=25°C)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	I_F	50	mA
	反向电压 Reverse Voltage	V_R	6	V
	功耗 Power Dissipation	P_D	70	mW
接收端 output	集电极功耗 Collector Power Dissipation	P_C	150	mW
	集电极电流 Collector Current	I_C	50	mA
	集电极-发射极电压 Collector-Emitter Voltage	V_{CEO}	80	V
	发射极-集电极电压 Emitter - Collector Voltage	V_{ECO}	7	V
总功耗 Total Power Dissipation		P_{tot}	200	mW
隔离电压 Isolation Voltage		V_{iso}	5000	V_{rms}
工作温度 Operating Temperature		T_{opr}	-55~+110	°C
存储温度 Storage Temperature		T_{stg}	-55~+125	°C
焊接温度 Soldering Temperature		T_{sol}	260	°C

晶体管光耦

Photo Transistor

HL826X

Photo Transistor

产品特性参数 Electro-optical Characteristics (Ta=25°C)

参数 Parameter	符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage	V_{F1} $I_F=10mA$	1.0	-	1.3	V
	正向电压 Forward Voltage	V_{F2} $I_F=20mA$	1.1	-	1.4	V
	反向电流 Reverse Current	I_R $V_R=5V$	-	-	10	μA
	终端电容 Terminal Capacitance	C_t $V=0, F=1kHz$	-	30	250	pF
接收端 Output	集电极暗电流 Collector Dark Current	I_{CEO} $V_{CE}=50V$	-	-	100	nA
	集电极-发射极击穿电压 Collector-Emitter Breakdown Voltage	BV_{CEO} $I_C=0.1mA, I_F=0$	80	-	-	V
	发射极-集电极击穿电压 Emitter-Collector Breakdown Voltage	BV_{ECO} $I_E=10\mu A, I_F=0$	7	-	-	V
传输特性 Transfer Characteristics	电流传输比 Current Transfer Ratio	CTR^* $I_F=5mA, V_{CE}=5V$	200	-	600	%
	集电极-发射极饱和压降 Collector-Emitter Saturation Voltage	$V_{CE(sat)}$ $I_F=1mA, I_C=1mA$	-	-	0.4	V
	隔离电阻 Isolation Resistance	R_{ISO} DC500V, 40~60%R.H.	1×10^{12}	-	-	Ω
	隔离电容 Isolation capacitance	C_{ISO} $V=0, F=1MHz$	-	0.6	1.0	pF
	截至频率 Cut-off Frequency	F_c $V_{CE}=5V, I_C=2mA,$ $R_L=100\Omega, -3dB$	-	80	-	KHz
	上升时间 Rise Time	T_r $V_{CE}=10V, I_C=2mA,$ $R_L=100\Omega$	-	-	12	μs
	下降时间 Fall Time	T_f $V_{CE}=2V, I_C=2mA,$ $R_L=100\Omega$	-	-	12	μs
	导通时间 Turn on time	T_{on} $V_{CE}=10V, I_C=2mA, R_L=1$ 00Ω	-	-	12	μs
	关断时间 Turn off time	T_{off} $V_{CE}=10V, I_C=2mA, R_L=1$ 00Ω	-	-	12	μs

注*: 电流传输比= $I_C/I_F \times 100\%$ 。

Note*: $CTR=I_C/I_F \times 100\%$ 。

电流传输比分档表 CTR Classification Table ($V_{CE}=5V, T_a=25^\circ C$)

代码 Code	分档 classification	符号 Symbol	条件 Condition	最小值 Min.	最大值 Max.
电流传输比 Current Transfer Ratio	D1	CTR1	$I_F=5mA, V_{CE}=5V$	300	450
		CTR2	$I_F=2mA, V_{CE}=5V$	200	500
	D2	CTR1	$I_F=5mA, V_{CE}=5V$	380	600
		CTR2	$I_F=2mA, V_{CE}=5V$	250	500
	D	CTR1	$I_F=5mA, V_{CE}=5V$	300	600
		CTR2	$I_F=2mA, V_{CE}=5V$	200	500
	C	CTR1	$I_F=5mA, V_{CE}=5V$	200	400
	None	CTR	$I_F=5mA, V_{CE}=5V$	200	600

Beijing Hongli Kunpeng International Trade Co., Ltd.

Tel: 86-10-57891098 MP:86-13001179378 Mail: info@hlkpint.com or lucyliu0807@163.com

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 Current Transfer Ratio vs. Forward Current

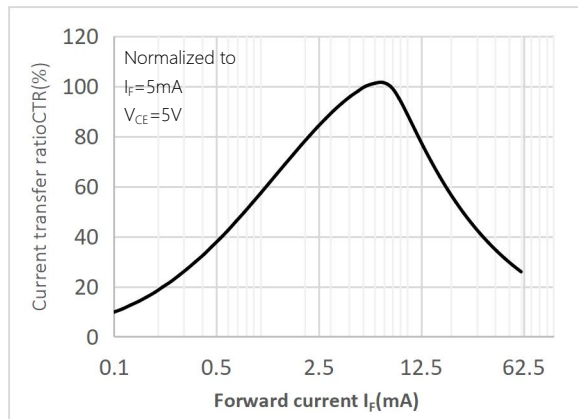


Fig.2 Forward Current vs Forward Voltage

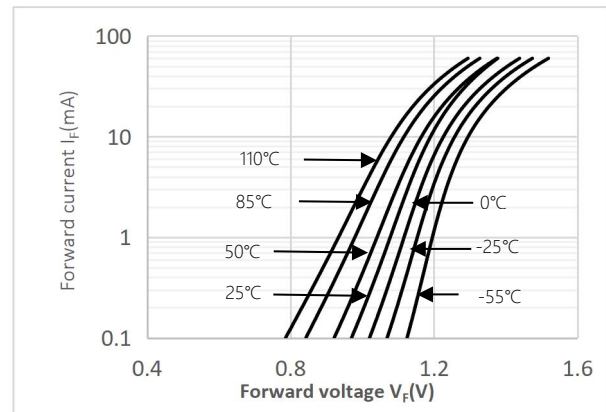


Fig.3 Collector Current vs. Collector-emitter Voltage

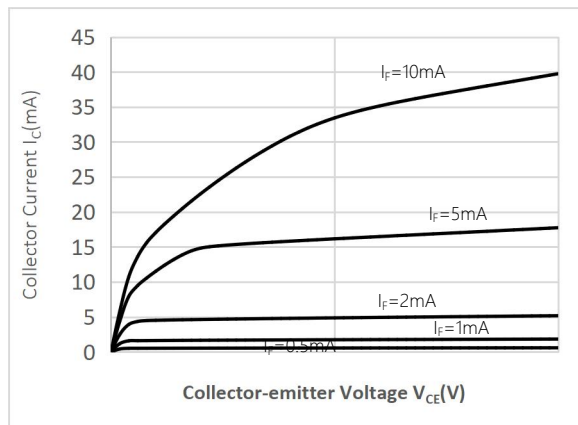


Fig.4 Relative Current Transfer Ratio vs. Ambient Temperature

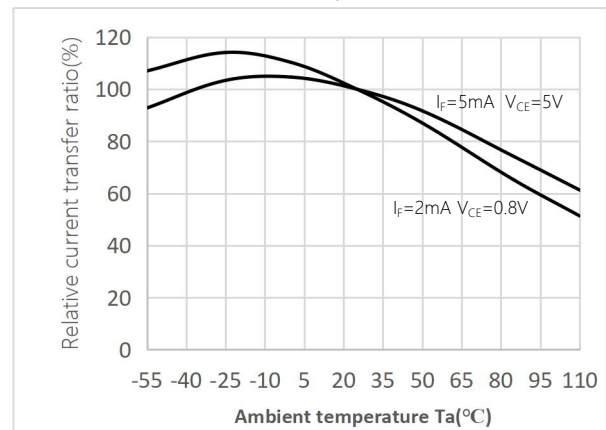


Fig.5 Collector-emitter Saturation Voltage vs. Ambient Temperature

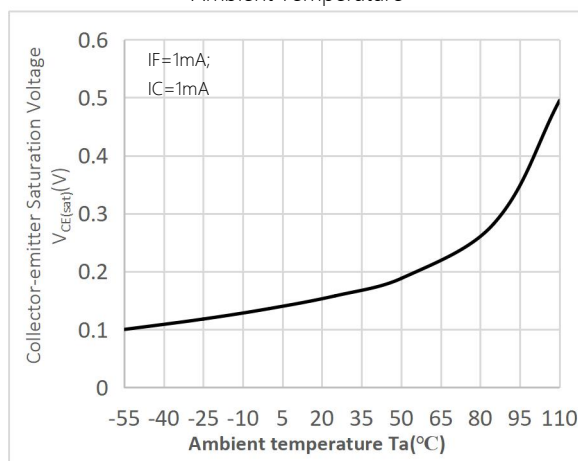


Fig.6 Collector Dark Current vs Ambient Temperature

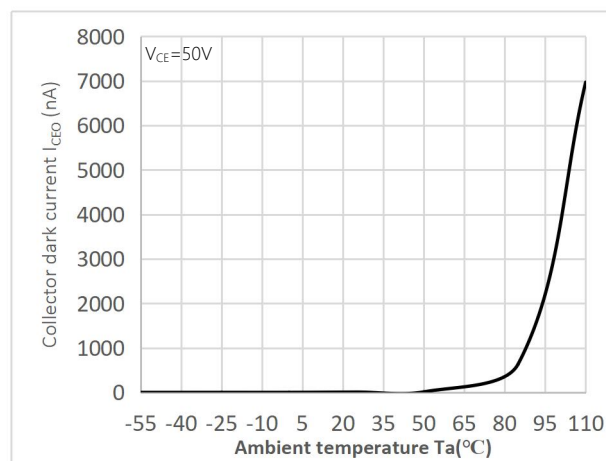


Fig.7 Response Time vs. Load Resistance

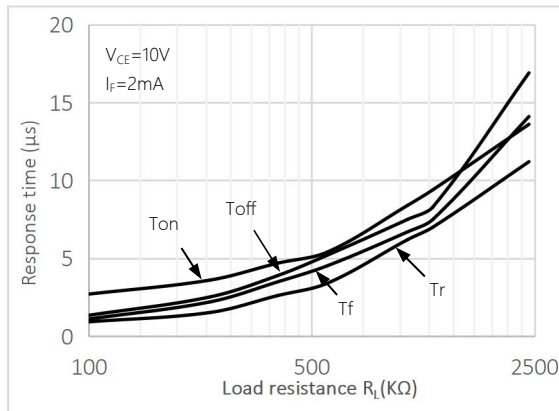


Fig.8 Frequency Response

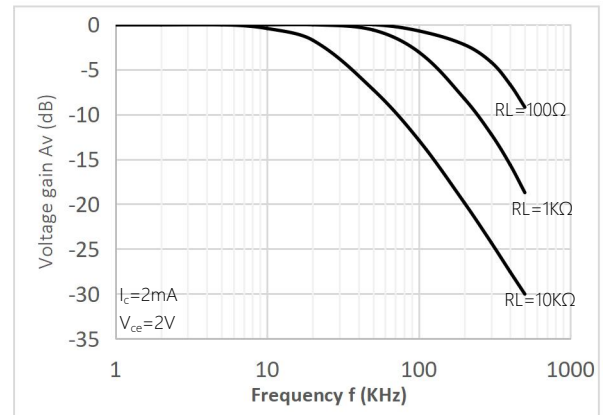


Fig.9 Collector-emitter Saturation Voltage vs. Forward Current

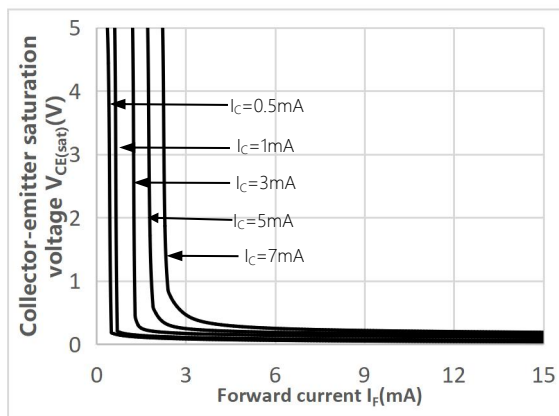
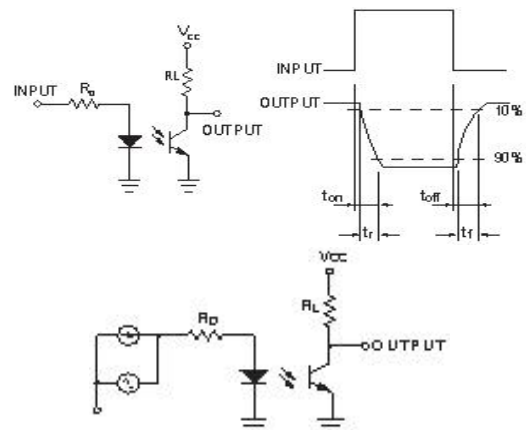


Fig.10 Test Circuits



晶体管光耦

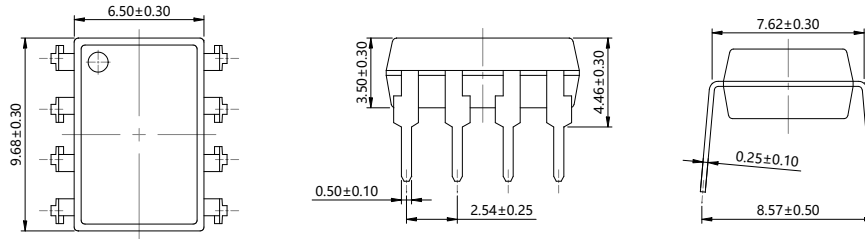
Photo Transistor

HL826X

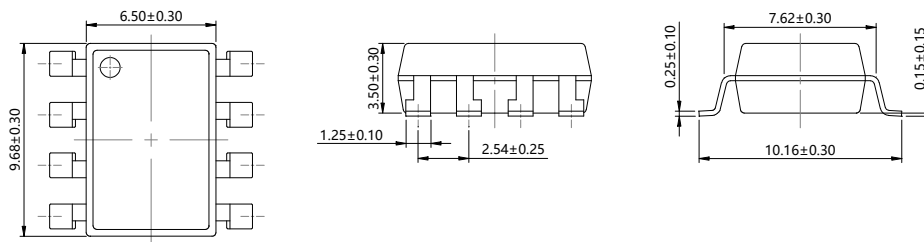
Photo Transistor

外形尺寸 Outline Dimensions

DIP8

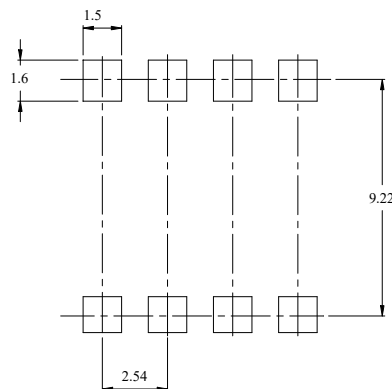


SMD8



单位 Unit: mm

建议焊盘布局 Recommended Pad Layout



单位 Unit: mm

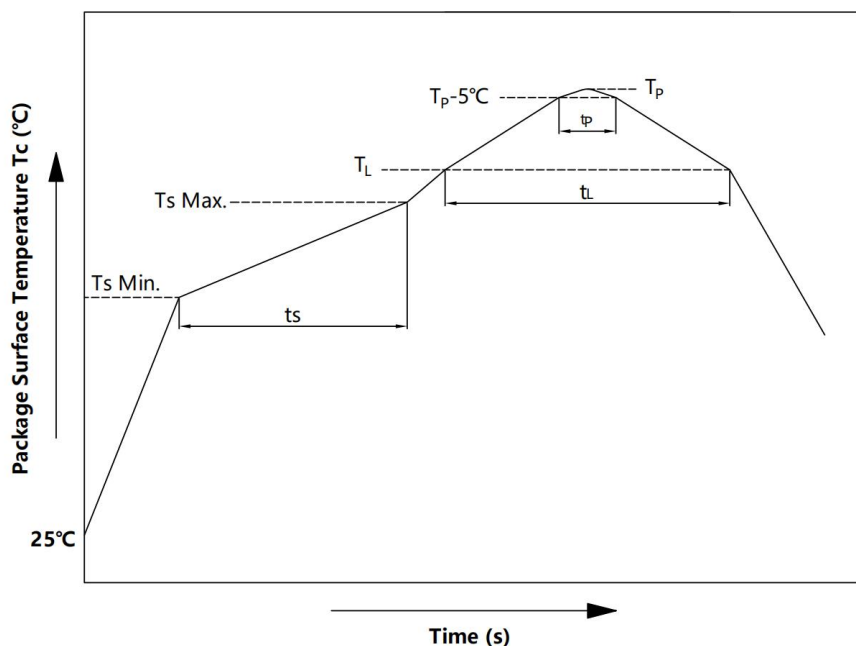
注：上图为产品正视图。

Note: The picture above is the front view of the product.

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回流焊温度曲线图 Solder Reflow Profile

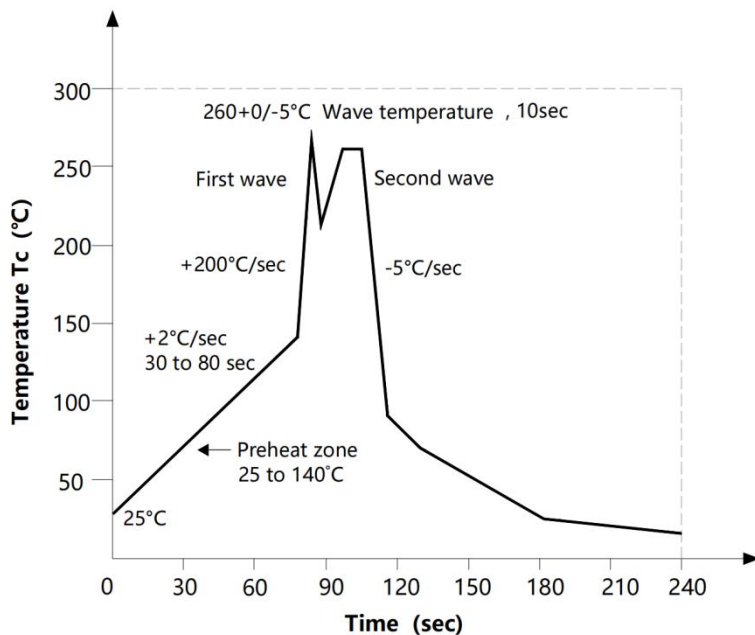


项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	T_s	150	200	$^\circ\text{C}$
预热时间 Preheat Time	t_s	60	120	s
升温速率 Ramp-Up Rate (T_L to T_P)	-	-	3	$^\circ\text{C/s}$
液相线温度 Liquidus Temperature	T_L	217		$^\circ\text{C}$
时间高于 T_L Time Above T_L	t_L	60	150	s
峰值温度 Peak Temperature	T_P	-	260	$^\circ\text{C}$
T_c 在 (T_P-5) 和 T_P 之间的时间 Time During Which T_c Is Between (T_P-5) and T_P	t_p	-	30	s
降温速率 Ramp-down Rate(T_P to T_L)	-	-	6	$^\circ\text{C/s}$

注 Note:

建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；

Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 Wave Soldering Profile**手工烙铁焊接 Soldering with hand soldering iron**

A. 手工烙铁焊仅用于产品返修或样品测试;

Hand soldering iron is only used for product rework or sample testing;

B. 手工烙铁焊要求: 温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$ 。

Hand soldering iron requirements: Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

晶体管光耦

Photo Transistor

HL826X

Photo Transistor

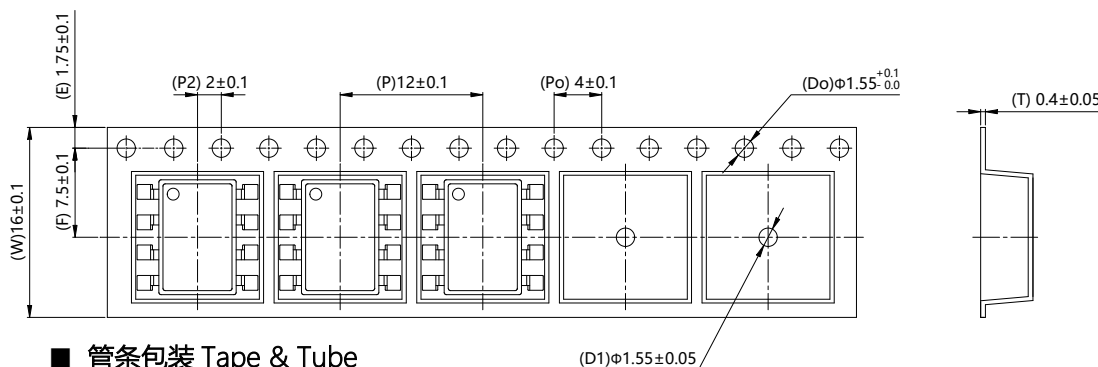
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SMD8	卷盘 ($\phi 330$ mm 蓝盘)	2000 只/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	340*60*340mm	620*360*365mm	首尾端空至少 200mm
DIP8	管装 (500*12*11mm)	100 只/管	50 管/盒	10 盒/箱	不适用	525*128*56mm	535*275*300mm	每管使用蓝白胶塞, 方向须一致
DIP8-M	管装 (500*13*11mm)	100 只/管	50 管/盒	10 盒/箱	不适用	525*136*58mm	535*295*310mm	
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SMD8	Reel ($\phi 330$ mm Blue)	1000 pcs/reel	2 reels/box	10 boxes/ctn	450*390*0.1mm	340*60*340mm	620*360*365mm	Leave at least 200mm of blank space at both ends
DIP8	Tube (500*12*11mm)	45 pcs /tube	50 tubes/box	10 boxes/ctn	NA	525*128*56mm	535*275*300mm	Use blue and white rubber plugs for each tube in the same direction
DIP8-M	Tube (500*13*11mm)	45 pcs /tube	50 tubes/box	10 boxes/ctn	NA	525*136*58mm	535*295*310mm	

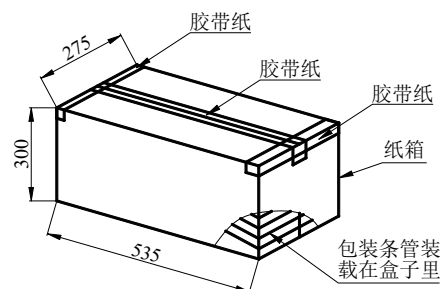
■ 编带包装 Tape & Reel

- 1) 每卷数量: 2000 只。
Qty/reel: 2000 pcs.
- 2) 每箱数量: 40000 只。
Qty/ctn: 40000 pcs.
- 3) 内包装: 每盒 2 盘。
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



■ 管条包装 Tape & Tube

- 1) 每管数量: 45 只。
Qty/Tube: 45 pcs.
- 2) 每箱数量: 22500 只。
Qty/ctn: 22500 pcs.
- 3) 内包装: 每盒 50 管。
Inner packing: 50 Tube/box.
- 4) 示意图 Schematic:



单位/Unit: mm

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Tel: 86-10-57891098 MP:86-13001179378 Mail: info@hlkpint.com or lucyliu0807@163.com

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